

C1206C184F3JACTU

Aliases (C1206C184F3JAC7800) SMD Comm U2J, Ceramic, 0.18 uF, 1%, 25 VDC, U2J, SMD, MLCC, Ultra-Stable, Low Loss, Class I, 1206, 1.5 mm



Click here for the 3D model.

| General Information | |
|--------------------------|---|
| Series | SMD Comm U2J |
| Style | SMD Chip |
| Description | SMD, MLCC, Ultra-Stable, Low Loss, Class I |
| Features | Ultra-Stable, Low Loss, Class I |
| RoHS | Yes |
| Termination | Tin |
| Marking | No |
| AEC-Q200 | No |
| Typical Component Weight | 36 mg |
| Shelf Life | 78 Weeks |
| MSL | 1 |

| Dimensions | | |
|------------|-----------------|--|
| Chip Size | 1206 | |
| L | 3.2mm +/-0.2mm | |
| W | 1.6mm +/-0.2mm | |
| т | 1.6mm +/-0.20mm | |
| S | 1.5mm MIN | |
| В | 0.5mm +/-0.25mm | |
| | | |

Packaging Specifications

PackagingT&R, 180mm, Plastic TapePackaging Quantity2000

| Specifications | |
|--|--|
| Capacitance | 0.18 uF |
| Measurement Condition | 1 kHz 1.0Vrms |
| Tolerance | 1% |
| Voltage DC | 25 VDC |
| Dielectric Withstanding Voltage | 62.5 VDC |
| Temperature Range | -55/+125°C |
| Temp. Coefficient | U2J |
| Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC) | -750+/-120 ppm/C, 1kHz 1.0Vrms |
| Dissipation Factor | 0.1% 1 kHz 1.0Vrms |
| Aging Rate | 0.1% Loss/Decade Hour: Referee Time is 1000 Hours |
| Insulation Resistance | 5.5556 GOhms |

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